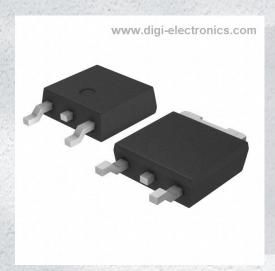


# **IRFR210PBF** Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number IRFR210PBF-DG

Manufacturer Vishay Siliconix

Manufacturer Product Number IRFR210PBF

Description MOSFET N-CH 200V 2.6A DPAK

Detailed Description N-Channel 200 V 2.6A (Tc) 2.5W (Ta), 25W (Tc) Surf

ace Mount DPAK



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

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# **Purchase and inquiry**

Manufacturer Product Number:	Manufacturer:
IRFR210PBF	Vishay Siliconix
Series:	Product Status:
	Active
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
200 V	2.6A (Tc)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ Id, Vgs:
10V	1.50hm @ 1.6A, 10V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
4V @ 250μA	8.2 nC @ 10 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	140 pF @ 25 V
FET Feature:	Power Dissipation (Max):
	2.5W (Ta), 25W (Tc)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Supplier Device Package:	Package / Case:
DPAK	TO-252-3, DPAK (2 Leads + Tab), SC-63
Base Product Number:	
IRER210	

# **Environmental & Export classification**

8541.29.0095

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Affected	EAR99
HTSUS:	

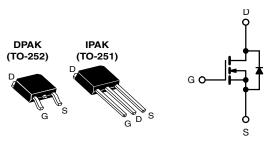


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COMPLIANT

HALOGEN FREE

### **Power MOSFET**



N-Channel MOSEFT

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	200			
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V 1.5			
Q <sub>g</sub> max. (nC)	8.2			
Q <sub>gs</sub> (nC)	1.8			
Q <sub>gd</sub> (nC)	4.5			
Configuration	Single			

#### **FEATURES**

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- Surface-mount (IRFR210, SiHFR210)
- Straight lead (IRFU210, SiHFU210)
- Available in tape and reel
- · Fast switching
- · Ease of paralleling
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **DESCRIPTION**

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFORMATION						
PACKAGE	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)	
Lead (Pb)-free and halogen-free	SiHFR210-GE3	SiHFR210TRL-GE3 a	-	SiHFR210TRR-GE3 a	SiHFU210-GE3	
Lead (Pb)-free	IRFR210PbF	IRFR210TRLPbF <sup>a</sup>	IRFR210TRPbF <sup>a</sup>	IRFR210TRRPbF	IRFU210PbF	
Lead (Pb)-free and halogen-free	IRFR210PbF-BE3 <sup>ab</sup>	IRFR210TRLPbF-BE3 ab	IRFR210TRPbF-BE3 ab	-	-	

### Notes

- a. See device orientation
- b. "-BE3" denotes alternate manufacturing location

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			$V_{DS}$	200	V
Gate-source voltage			$V_{GS}$	± 20	V
Continuous drain current	V at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	1_	2.6	
Continuous drain current	VGS at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	1.7	Α
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	10	
Linear derating factor				0.20	W/°C
Linear derating factor (PCB mount) e				0.020	
Single pulse avalanche Energy <sup>b</sup>			E <sub>AS</sub>	95	mJ
Avalanche current <sup>a</sup>			I <sub>AR</sub>	2.7	Α
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	2.5	mJ
Maximum power dissipation $T_C = 25 ^{\circ}C$		P <sub>D</sub>	25	W	
Maximum power dissipation (PCB mount) e	dissipation (PCB mount) e T <sub>A</sub> = 25 °C		LD	2.5	VV
Peak diode recovery dV/dt <sup>c</sup>			dV/dt	5.0	V/ns
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Soldering recommendations (peak temperature) <sup>d</sup> for 10 s				260	

#### **Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 28 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 2.6 A (see fig. 12)
- c.  $I_{SD} \le 2.6$  A,  $dI/dt \le 70$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C
- d. 1.6 mm from case
- e. When mounted on 1" square PCB (FR-4 or G-10 material)

Document Number: 91268



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum junction-to-ambient	$R_{thJA}$	-	-	110	
Maximum junction-to-ambient (PCB mount) a	$R_{thJA}$	-	-	50	°C/W
Maximum junction-to-case (drain)	$R_{thJC}$	-	-	5.0	

#### Note

a. When mounted on 1" square PCB (FR-4 or G-10 material)

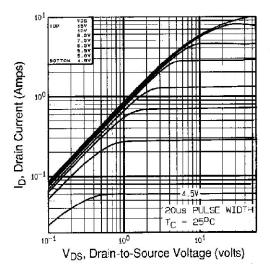
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, un	nless otherw	ise noted)		ı	ı	1	
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> = 250 μA	200	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.30	-	V/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-source leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Zero gate voltage drain current	I <sub>DSS</sub>		= 200 V, V <sub>GS</sub> = 0 V V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	25 250	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}$	$I_D = 1.6 \text{ A}^b$	_	_	1.5	Ω
Forward transconductance	9 <sub>fs</sub>		= 50 V, I <sub>D</sub> = 1.6 A <sup>b</sup>	0.80	_	-	S
Dynamic	315	- 53			<u> </u>	<u> </u>	
Input capacitance	C <sub>iss</sub>		V 0V	_	140	-	
Output capacitance	Coss	-	$\begin{array}{c} V_{GS} = 0 \text{ V}, \\ V_{DS} = 25 \text{ V}, \\ \text{f} = 1.0 \text{ MHz}, \text{see fig. 5} \end{array}$		53	-	pF
Reverse transfer capacitance	C <sub>rss</sub>	f = 1			15	-	, p.
Total gate charge	Qg			-	-	8.2	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 3.3 \text{ A}, V_{DS} = 160 \text{ V},$ see fig. 6 and 13 b		-	1.8	nC
Gate-drain charge	Q <sub>gd</sub>				-	4.5	
Turn-on delay time	t <sub>d(on)</sub>	$V_{DD}=100~\text{V, I}_D=3.3~\text{A,}$ $R_g=24~\Omega,~R_D=30~\Omega,~\text{see fig. }10~\text{b}$		-	8.2	-	
Rise time	t <sub>r</sub>			-	17	-	ns
Turn-off delay time	t <sub>d(off)</sub>			-	14	-	
Fall time	t <sub>f</sub>			-	8.9	-	
Internal drain inductance	L <sub>D</sub>	Between lead	,	-	4.5	-	
Internal source inductance	L <sub>S</sub>	6 mm (0.25") from package and center of die contact		-	7.5	-	nH
Drain-source body diode characteristics							
Continuous source-drain diode current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	2.6	
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>			-	-	10	Α
Body diode voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	$I_{S} = 2.6 \text{ A}, V_{GS} = 0 \text{ V}^{\text{ b}}$	-	-	2.0	V
Body diode reverse recovery time	t <sub>rr</sub>	T 05 00 1	0.0 A 41/4+ 400 A/ b	-	150	310	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$T_J = 25  ^{\circ}\text{C}, I_F = 3.3  \text{A}, dI/dt = 100  \text{A/}\mu\text{s}^{\text{b}}$		-	0.60	1.4	μC
Forward turn-on time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>I</sub>		L <sub>D</sub> )			

#### **Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width  $\leq 300~\mu s;~duty~cycle \leq 2~\%$

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

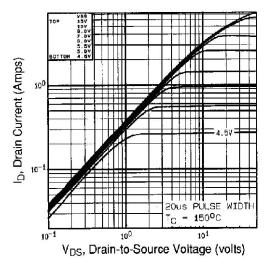


Fig. 1 - Typical Output Characteristics,  $T_C = 150$  °C

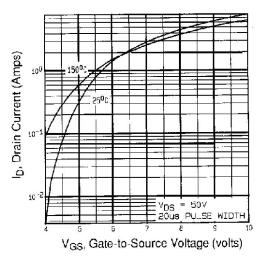


Fig. 2 - Typical Transfer Characteristics

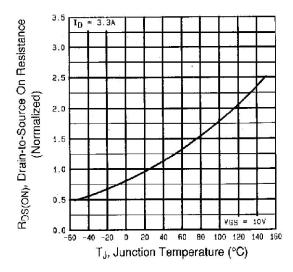


Fig. 3 - Normalized On-Resistance vs. Temperature

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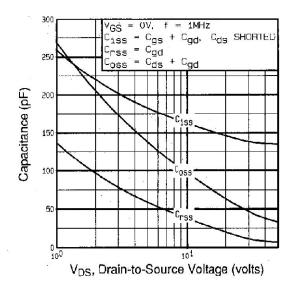


Fig. 4 - Typical Capacitance vs. Drain-to-Source Voltage

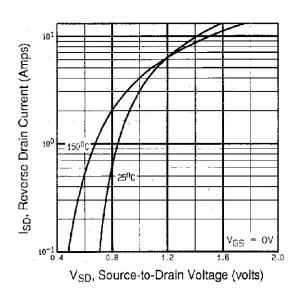


Fig. 6 - Typical Source-Drain Diode Forward Voltage

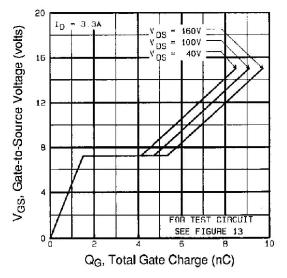


Fig. 5 - Typical Gate Charge vs. Gate-to-Source Voltage

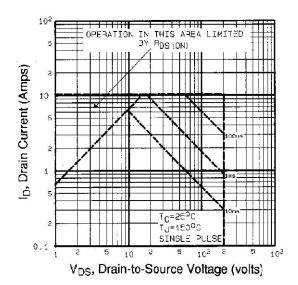


Fig. 7 - Maximum Safe Operating Area

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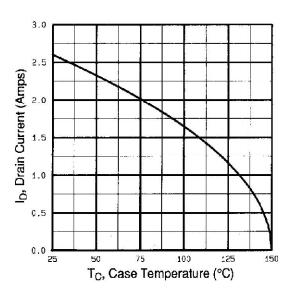


Fig. 8 - Maximum Drain Current vs. Case Temperature

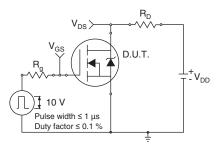


Fig. 10a - Switching Time Test Circuit

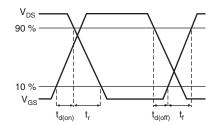


Fig. 10b - Switching Time Waveforms

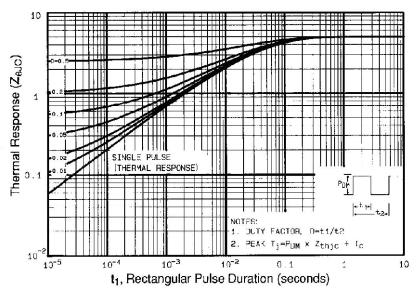


Fig. 9 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

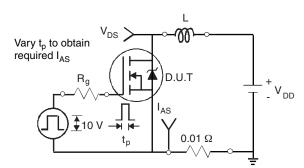


Fig. 12a - Unclamped Inductive Test Circuit

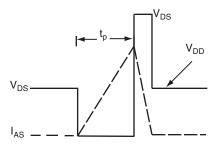


Fig. 12b - Unclamped Inductive Waveforms

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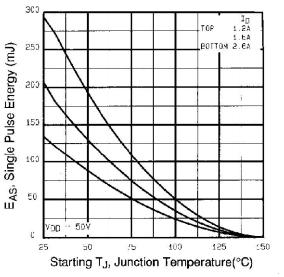


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

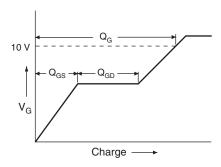


Fig. 13a - Basic Gate Charge Waveform

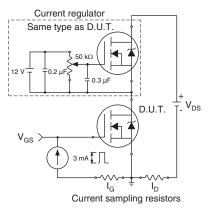


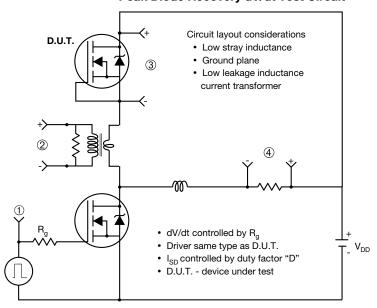
Fig. 13b - Gate Charge Test Circuit

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### IRFR210, IRFU210, SiHFR210, SiHFU210

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#### Peak Diode Recovery dV/dt Test Circuit



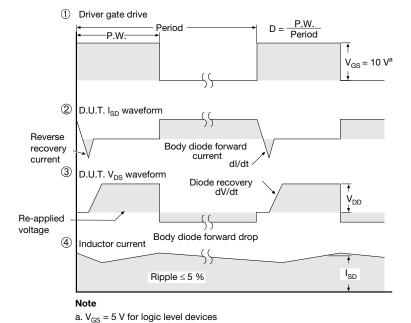


Fig. 10 - For N-Channel

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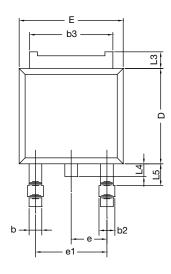
# **Package Information**

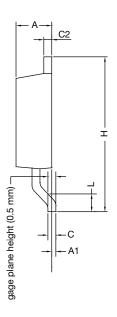
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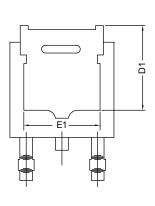
### **TO-252AA Case Outline**

#### **VERSION 1: FACILITY CODE = Y**

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	MILLIMETERS		
DIM.	MIN.	MAX.	
Α	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
E	6.35	6.73	
E1	4.32	=	
Н	9.40	10.41	
е	2.28 BSC		
e1	4.56 BSC		
L	1.40	1.78	
L3	0.89	1.27	
L4	- 1.02		
L5	1.01 1.52		

#### Note

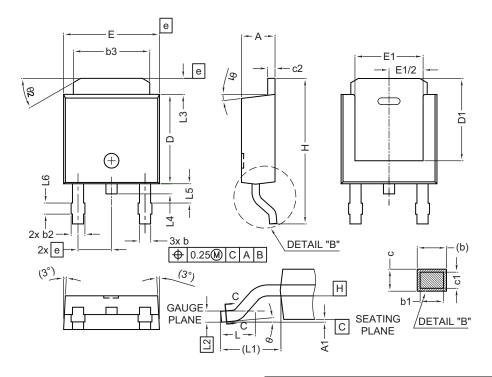
• Dimension L3 is for reference only



# **Package Information**

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#### **VERSION 2: FACILITY CODE = N**



	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
Е	6.35	6.73	
E1	4.32 -		
е	2.29 BSC		
Н	9.94 10.34		

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	1 ref.	
L2	0.51	BSC	
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

#### Notes

- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- · Radius on terminal is optional

ECN: E22-0399-Rev. R, 03-Oct-2022

DWG: 5347



# **Application Note 826**

Vishay Siliconix

### **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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